

PMV48XPAR Datasheet



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| | |
|------------------------------|--|
| DiGi Electronics Part Number | PMV48XPAR-DG |
| Manufacturer | Nexperia USA Inc. |
| Manufacturer Product Number | PMV48XPAR |
| Description | MOSFET P-CH 20V 3.5A TO236AB |
| Detailed Description | P-Channel 20 V 3.5A (Ta) 510mW (Ta), 4.15W (Tc) Surface Mount TO-236AB |



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Purchase and inquiry

Manufacturer Product Number:

PMV48XP

Series:

-

FET Type:

P-Channel

Drain to Source Voltage (Vdss):

20 V

Drive Voltage (Max Rds On, Min Rds On):

2.5V, 4.5V

Vgs(th) (Max) @ Id:

1.25V @ 250µA

Vgs (Max):

±12V

FET Feature:

-

Operating Temperature:

150°C (TJ)

Qualification:

AEC-Q100

Supplier Device Package:

TO-236AB

Base Product Number:

PMV48

Manufacturer:

Nexperia USA Inc.

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

3.5A (Ta)

Rds On (Max) @ Id, Vgs:

55mOhm @ 2.4A, 4.5V

Gate Charge (Qg) (Max) @ Vgs:

11 nC @ 4.5 V

Input Capacitance (Ciss) (Max) @ Vds:

1000 pF @ 10 V

Power Dissipation (Max):

510mW (Ta), 4.15W (Tc)

Grade:

Automotive

Mounting Type:

Surface Mount

Package / Case:

TO-236-3, SC-59, SOT-23-3

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



PMV48XPA

20 V, P-channel Trench MOSFET

10 March 2014

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic-level compatible
- Trench MOSFET technology
- Very fast switching
- AEC-Q101 qualified

3. Applications

- High-side loadswitch
- High-speed line driver
- Relay driver
- Switching circuits

4. Quick reference data

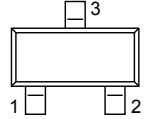
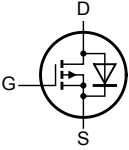
Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|---|-----|-----|------|------|
| V_{DS} | drain-source voltage | $T_{amb} = 25\text{ °C}$ | - | - | -20 | V |
| V_{GS} | gate-source voltage | | -12 | - | 12 | V |
| I_D | drain current | $V_{GS} = -4.5\text{ V}; T_{amb} = 25\text{ °C}$ | [1] | - | -3.5 | A |
| Static characteristics | | | | | | |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = -4.5\text{ V}; I_D = -2.4\text{ A}; T_j = 25\text{ °C}$ | - | 48 | 55 | mΩ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm^2 .

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|---|--|
| 1 | G | gate |  <p>TO-236AB (SOT23)</p> |  <p>017aaa094</p> |
| 2 | S | source | | |
| 3 | D | drain | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|----------|--|---------|
| | Name | Description | Version |
| PMV48XPA | TO-236AB | plastic surface-mounted package; 3 leads | SOT23 |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMV48XPA | %DZ |

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|---------------------------|-------------------------|---|-----|-----|------|------|
| V_{DS} | drain-source voltage | $T_{amb} = 25\text{ °C}$ | | - | -20 | V |
| V_{GS} | gate-source voltage | | | -12 | 12 | V |
| I_D | drain current | $V_{GS} = -4.5\text{ V}; T_{amb} = 25\text{ °C}$ | [1] | - | -3.5 | A |
| | | $V_{GS} = -4.5\text{ V}; T_{amb} = 100\text{ °C}$ | [1] | - | -2.2 | A |
| I_{DM} | peak drain current | $T_{amb} = 25\text{ °C}; \text{single pulse}; t_p \leq 10\text{ }\mu\text{s}$ | | - | -14 | A |
| P_{tot} | total power dissipation | $T_{amb} = 25\text{ °C}$ | [2] | - | 510 | mW |
| | | | [1] | - | 930 | mW |
| | | $T_{sp} = 25\text{ °C}$ | | - | 4150 | mW |
| T_j | junction temperature | | | - | 150 | °C |
| T_{amb} | ambient temperature | | | -55 | 150 | °C |
| T_{stg} | storage temperature | | | -65 | 150 | °C |
| Source-drain diode | | | | | | |
| I_S | source current | $T_{amb} = 25\text{ °C}$ | [1] | - | -1 | A |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm^2 .

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

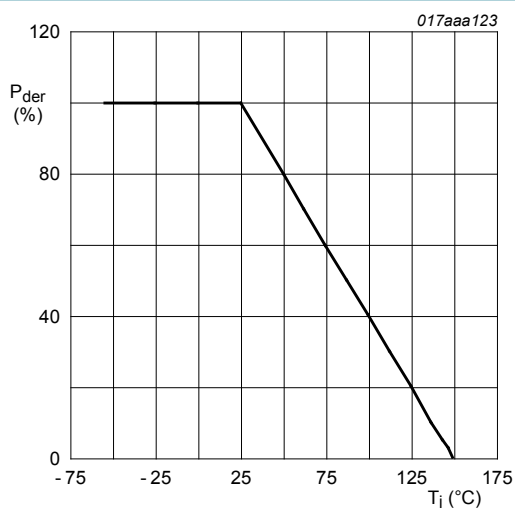


Fig. 1. Normalized total power dissipation as a function of junction temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ\text{C})}} \times 100\%$$

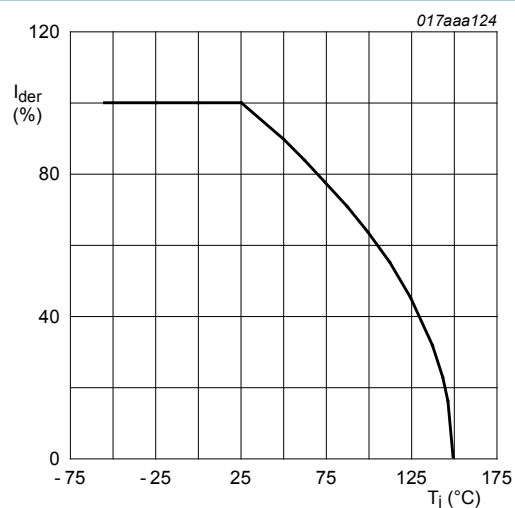
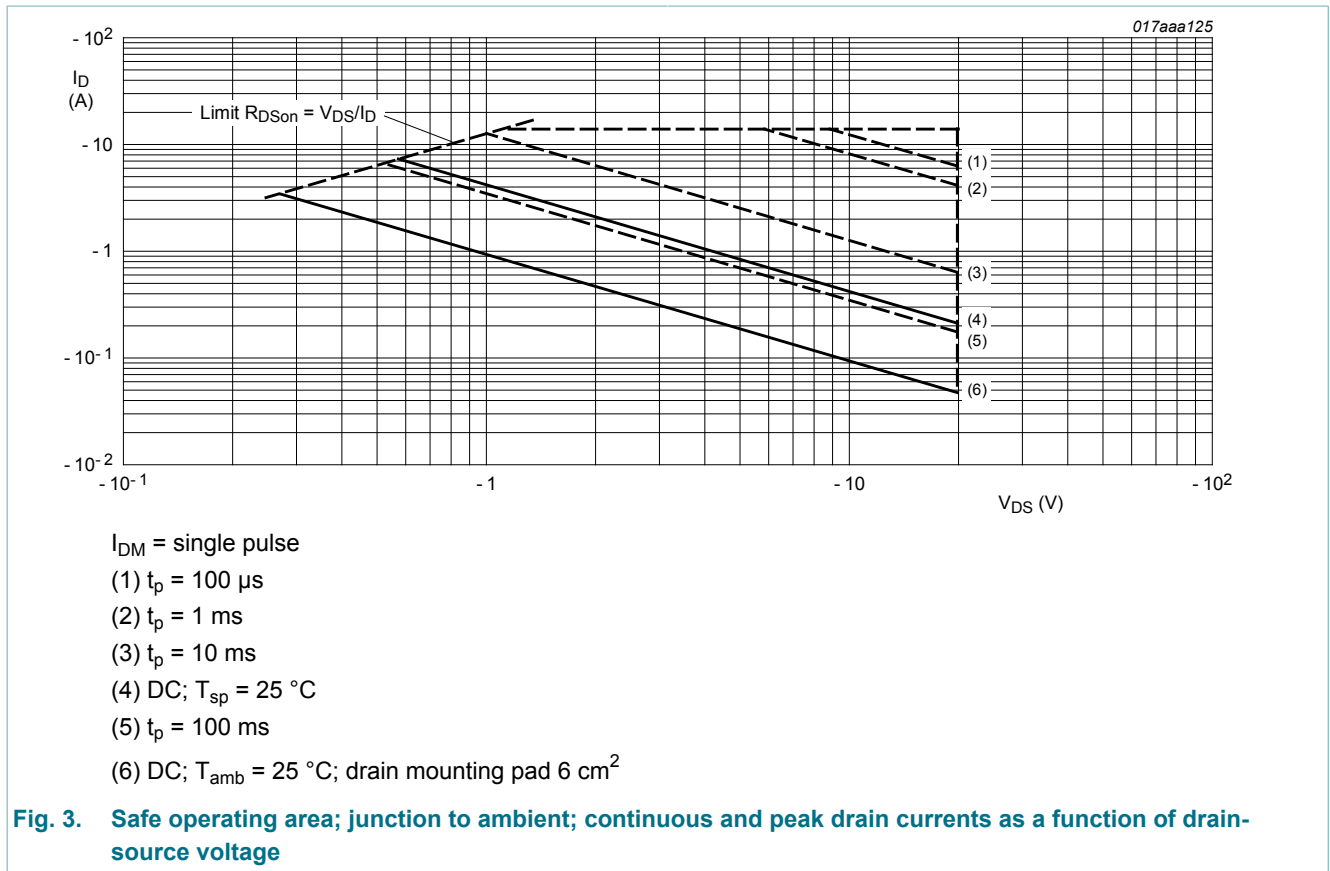


Fig. 2. Normalized continuous drain current as a function of junction temperature

$$I_{der} = \frac{I_D}{I_{D(25^\circ\text{C})}} \times 100\%$$



9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------|--|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | 213 | 245 | K/W |
| | | | [2] | - | 117 | 135 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | - | 25 | 30 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm^2 .

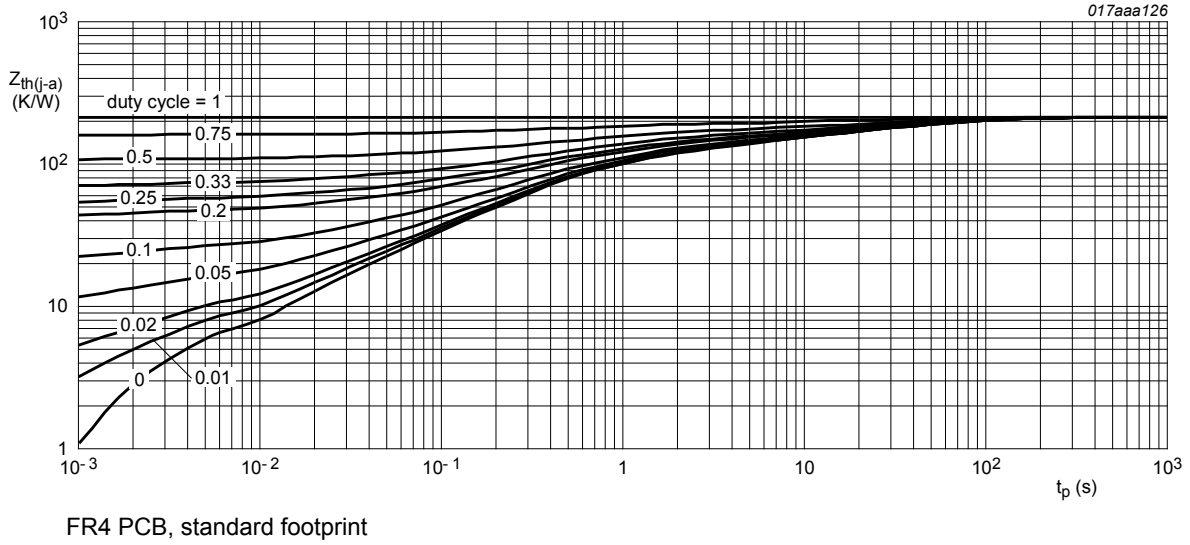


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

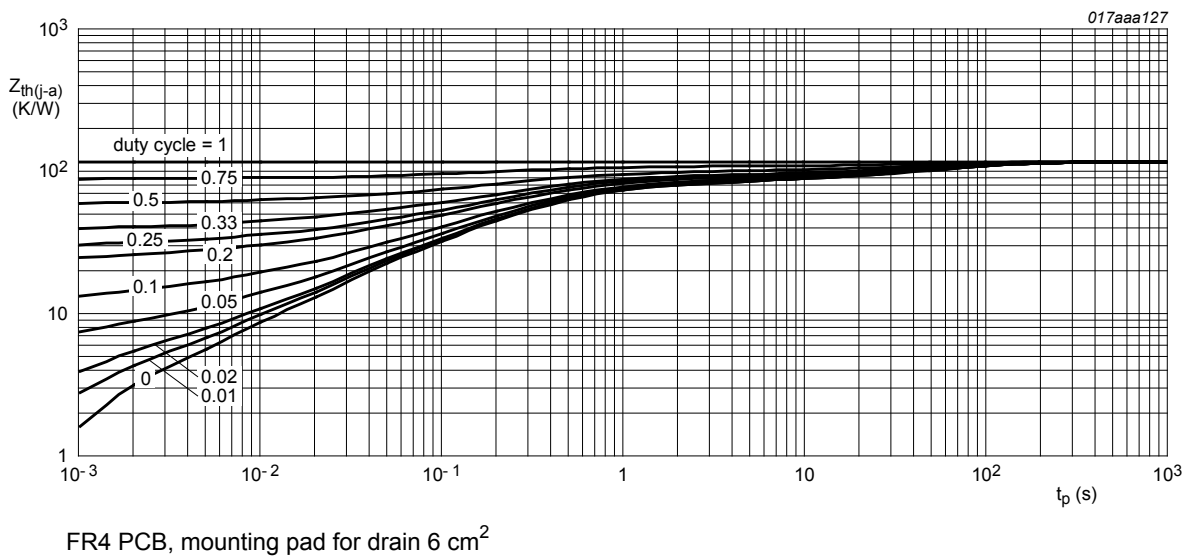


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|----------------------------------|--|--|-------|-------|---------------|
| Static characteristics | | | | | | |
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $I_D = -250 \mu\text{A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$ | -20 | - | - | V |
| V_{GSth} | gate-source threshold voltage | $I_D = -250 \mu\text{A}$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ }^\circ\text{C}$ | -0.75 | -1 | -1.25 | V |
| I_{DSS} | drain leakage current | $V_{DS} = -20 \text{ V}$; $V_{GS} = 0 \text{ V}$; $T_{amb} = 25 \text{ }^\circ\text{C}$ | - | - | -1 | μA |
| I_{GSS} | gate leakage current | $V_{GS} = -12 \text{ V}$; $V_{DS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | - | -100 | nA |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = -4.5 \text{ V}$; $I_D = -2.4 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 48 | 55 | m Ω |
| | | $V_{GS} = -4.5 \text{ V}$; $I_D = -2.4 \text{ A}$; $T_j = 150 \text{ }^\circ\text{C}$ | - | 70 | 80 | m Ω |
| | | $V_{GS} = -2.5 \text{ V}$; $I_D = -2 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 71 | 81 | m Ω |
| g_{fs} | forward transconductance | $V_{DS} = -12 \text{ V}$; $I_D = -2 \text{ A}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 12 | - | S |
| Dynamic characteristics | | | | | | |
| $Q_{G(tot)}$ | total gate charge | $V_{DS} = -10 \text{ V}$; $I_D = -1 \text{ A}$; $V_{GS} = -4.5 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 8.5 | 11 | nC |
| Q_{GS} | gate-source charge | | - | 1.8 | - | nC |
| Q_{GD} | gate-drain charge | | - | 1.8 | - | nC |
| C_{iss} | input capacitance | $V_{DS} = -10 \text{ V}$; $f = 1 \text{ MHz}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 1000 | - | pF |
| C_{oss} | output capacitance | | - | 130 | - | pF |
| C_{rss} | reverse transfer capacitance | | - | 90 | - | pF |
| $t_{d(on)}$ | turn-on delay time | | $V_{DS} = -10 \text{ V}$; $I_D = -1 \text{ A}$; $V_{GS} = -4.5 \text{ V}$; $R_{G(ext)} = 6 \Omega$; $T_j = 25 \text{ }^\circ\text{C}$ | - | 11 | - |
| t_r | rise time | - | | 13 | - | ns |
| $t_{d(off)}$ | turn-off delay time | - | | 61 | - | ns |
| t_f | fall time | - | | 23 | - | ns |
| Source-drain diode | | | | | | |
| V_{SD} | source-drain voltage | $I_S = -2.4 \text{ A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$ | - | -0.82 | -1.2 | V |

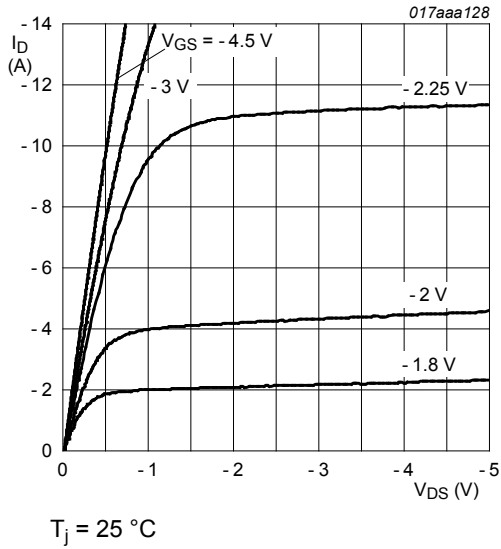


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

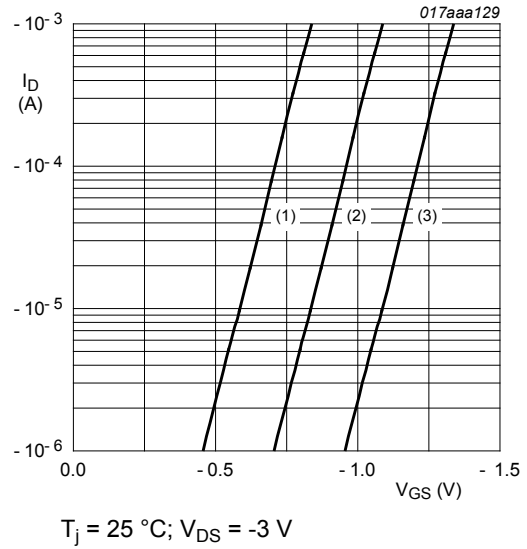


Fig. 7. Sub-threshold drain current as a function of gate-source voltage
 $T_j = 25\text{ }^\circ\text{C}$; $V_{DS} = -3\text{ V}$
 (1) minimum values
 (2) typical values
 (3) maximum values

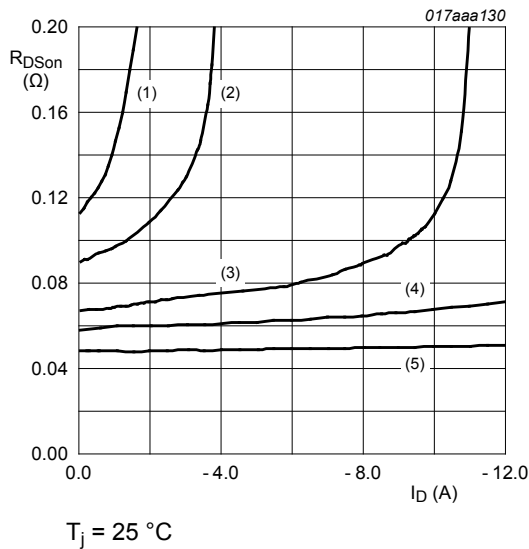


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values
 $T_j = 25\text{ }^\circ\text{C}$
 (1) $V_{GS} = -1.8\text{ V}$
 (2) $V_{GS} = -2.0\text{ V}$
 (3) $V_{GS} = -2.25\text{ V}$
 (4) $V_{GS} = -3.0\text{ V}$
 (5) $V_{GS} = -4.5\text{ V}$

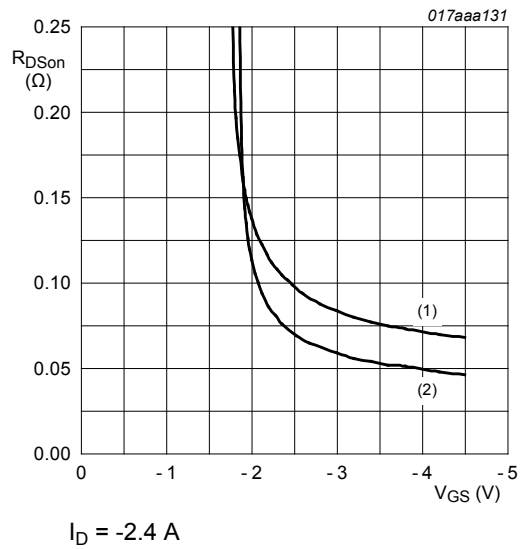
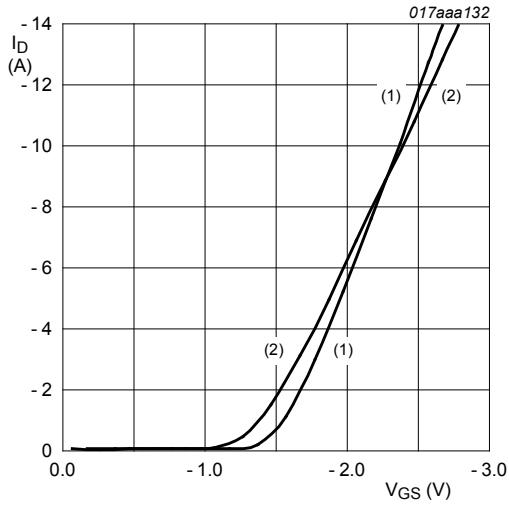


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values
 $I_D = -2.4\text{ A}$
 (1) $T_j = 125\text{ }^\circ\text{C}$
 (2) $T_j = 25\text{ }^\circ\text{C}$



$V_{DS} > I_D \times R_{DS(on)}$

(1) $T_j = 25\text{ }^\circ\text{C}$

(2) $T_j = 150\text{ }^\circ\text{C}$

Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

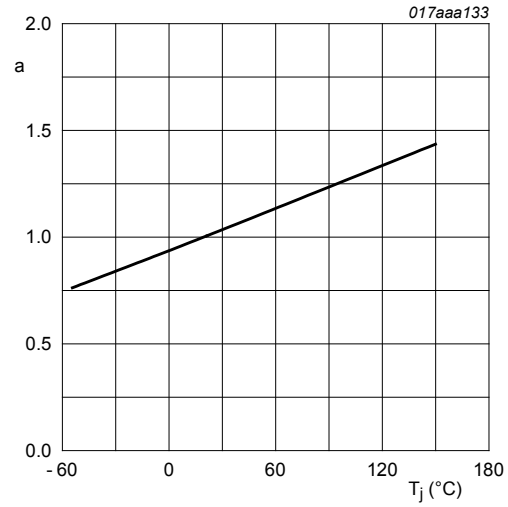
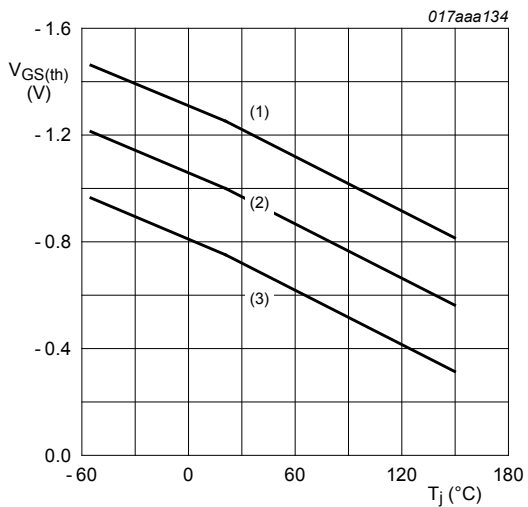


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

$$a = \frac{R_{DS(on)}}{R_{DS(on)@25^\circ\text{C}}}$$



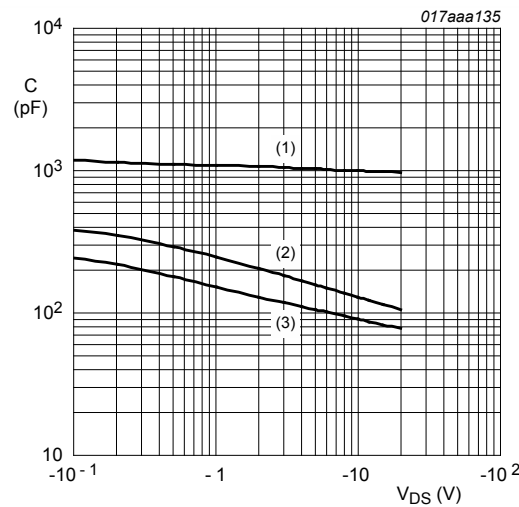
$I_D = -0.25\text{ mA}; V_{DS} = V_{GS}$

(1) maximum values

(2) typical values

(3) minimum values

Fig. 12. Gate-source threshold voltage as a function of junction temperature



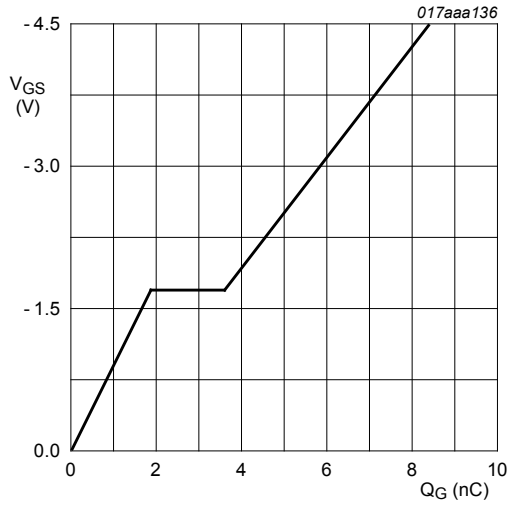
$f = 1\text{ MHz}; V_{GS} = 0\text{ V}$

(1) C_{iss}

(2) C_{oss}

(3) C_{rss}

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$I_D = -2.4 \text{ A}; V_{DS} = -10 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 14. Gate-source voltage as a function of gate charge; typical values

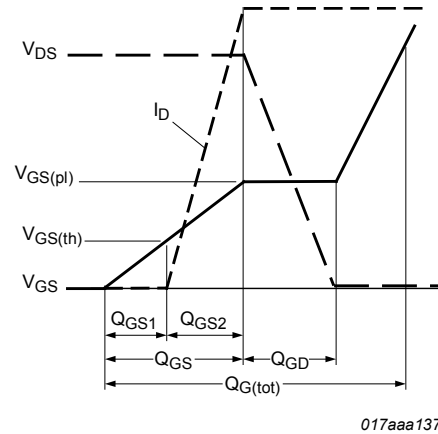
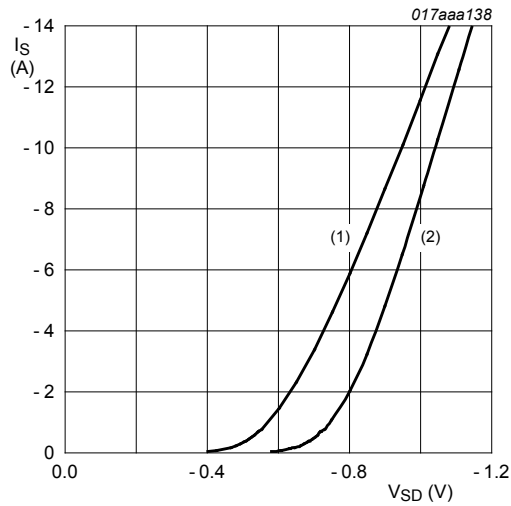


Fig. 15. Gate charge waveform definitions



$V_{GS} = 0 \text{ V}$
 (1) $T_j = 150 \text{ }^\circ\text{C}$
 (2) $T_j = 25 \text{ }^\circ\text{C}$

Fig. 16. Source current as a function of source-drain voltage; typical values

11. Test information

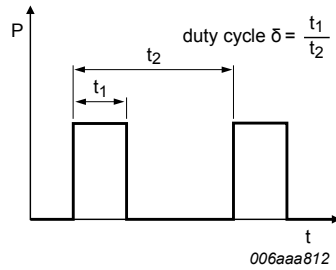


Fig. 17. Duty cycle definition

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

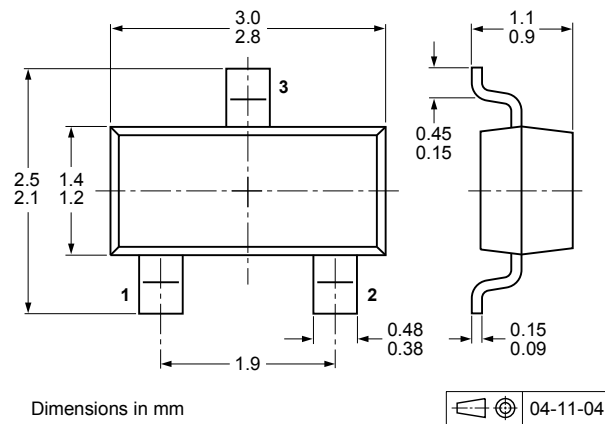


Fig. 18. Package outline TO-236AB (SOT23)

13. Soldering

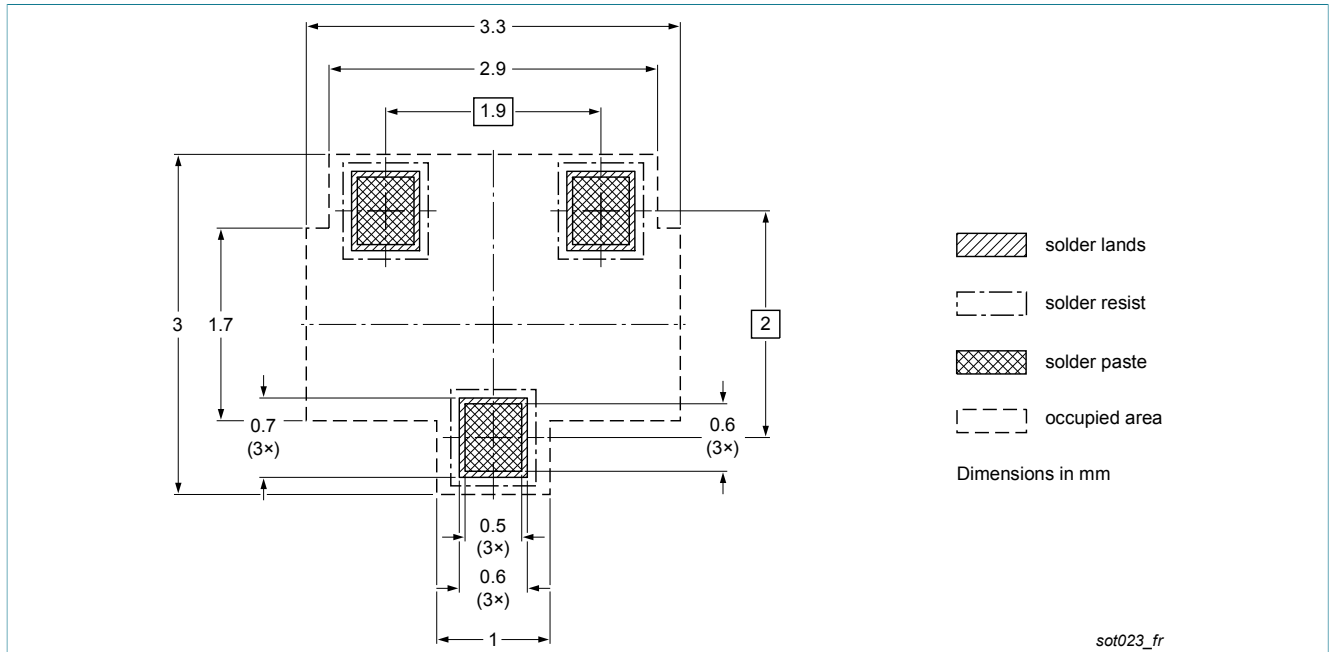


Fig. 19. Reflow soldering footprint for TO-236AB (SOT23)

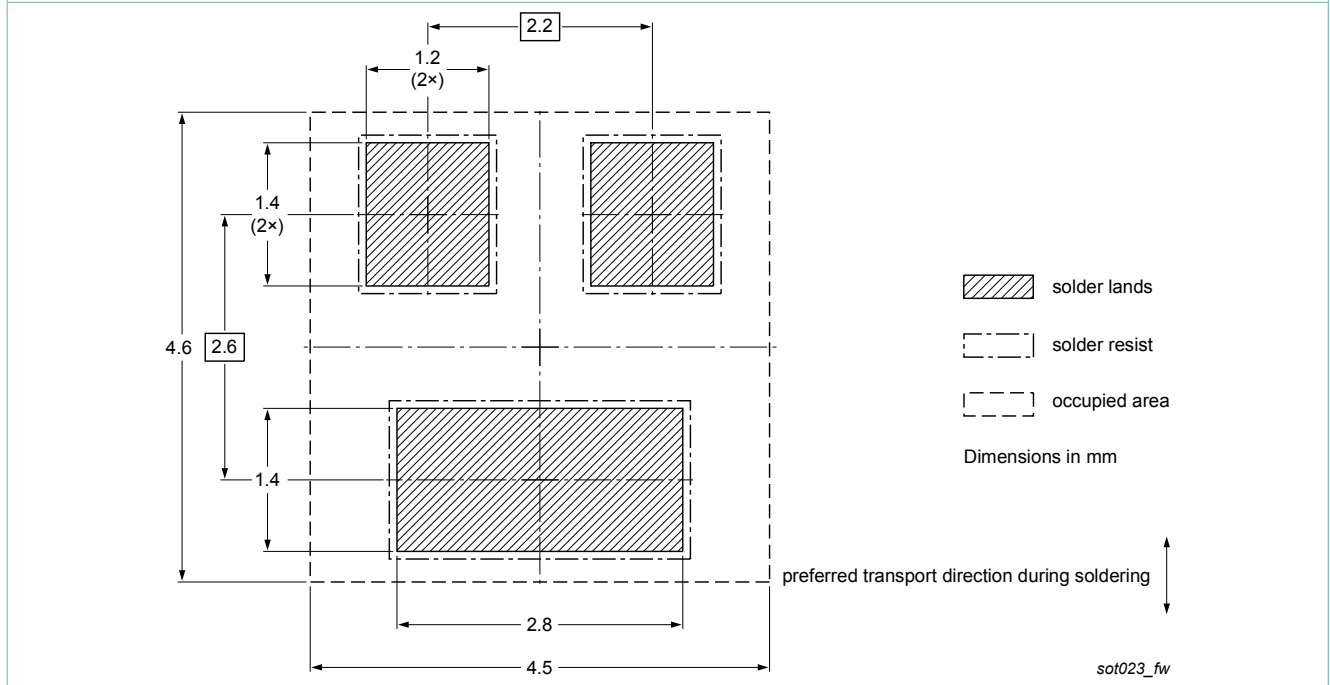


Fig. 20. Wave soldering footprint for TO-236AB (SOT23)

14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PMV48XPA v.1 | 20140310 | Product data sheet | - | - |

15. Legal information

15.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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Date of release: 10 March 2014

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